



US 20050015133A1

(19) **United States**

(12) **Patent Application Publication**  
**Ibrahim et al.**

(10) **Pub. No.: US 2005/0015133 A1**

(43) **Pub. Date: Jan. 20, 2005**

(54) **MULTI-ELECTRODE COCHLEAR IMPLANT SYSTEM WITH DISTRIBUTED ELECTRONICS**

(30) **Foreign Application Priority Data**

Jun. 29, 2001 (AU)..... PR 6048

(76) Inventors: **Ibrahim Hanna Ibrahim**, New South Wales (AU); **John L. Parker**, New South Wales (AU)

**Publication Classification**

(51) **Int. Cl.<sup>7</sup>** ..... **A61N 1/05**

(52) **U.S. Cl.** ..... **607/137; 607/57**

Correspondence Address:

**CHRISTIE, PARKER & HALE, LLP**  
**PO BOX 7068**  
**PASADENA, CA 91109-7068 (US)**

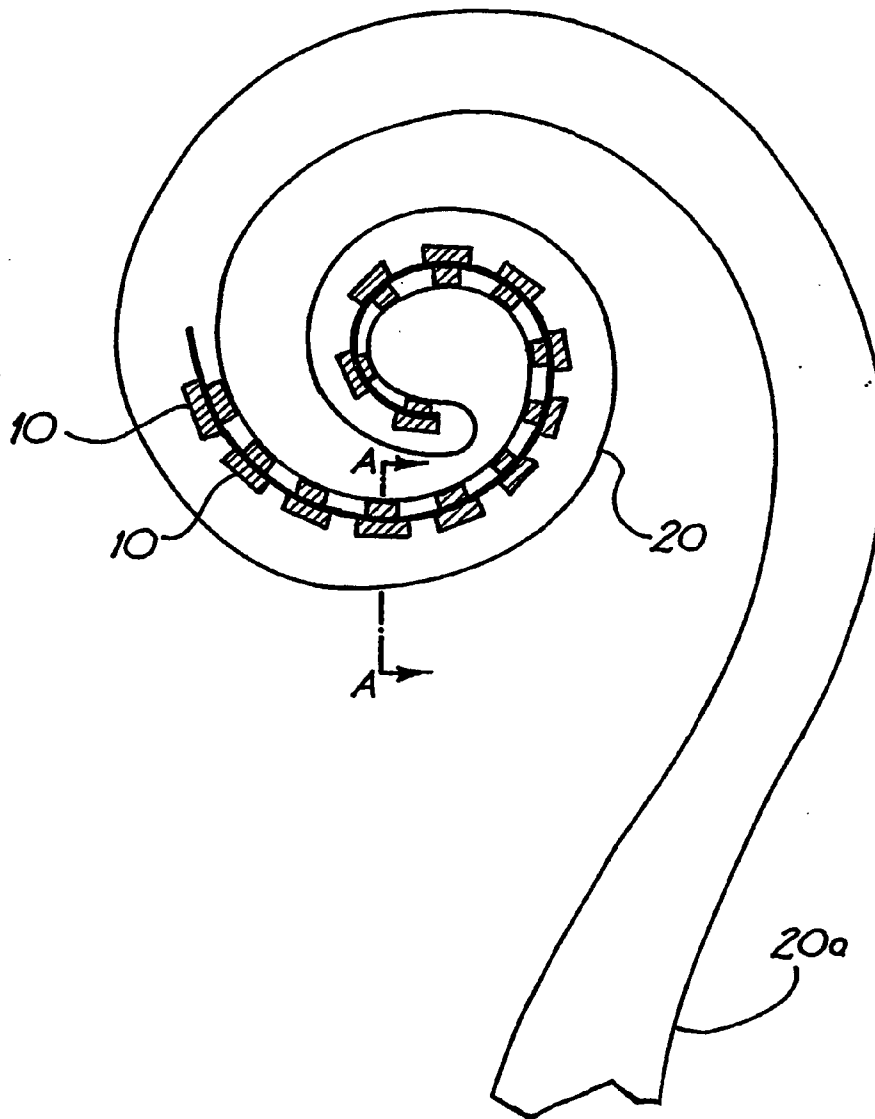
(57) **ABSTRACT**

An implantable tissue-stimulating device comprising a carrier member having a plurality of electrodes (11) mounted thereon, and at least one signal transmitting wire (13) extending through at least a portion of the carrier member and adapted to transmit signals through the carrier member to and/or from the electrodes (11). The number of wires (13) within the carrier member is less than the number of electrodes (11) mounted thereon.

(21) Appl. No.: **10/481,209**

(22) PCT Filed: **Jun. 28, 2002**

(86) PCT No.: **PCT/AU02/00835**



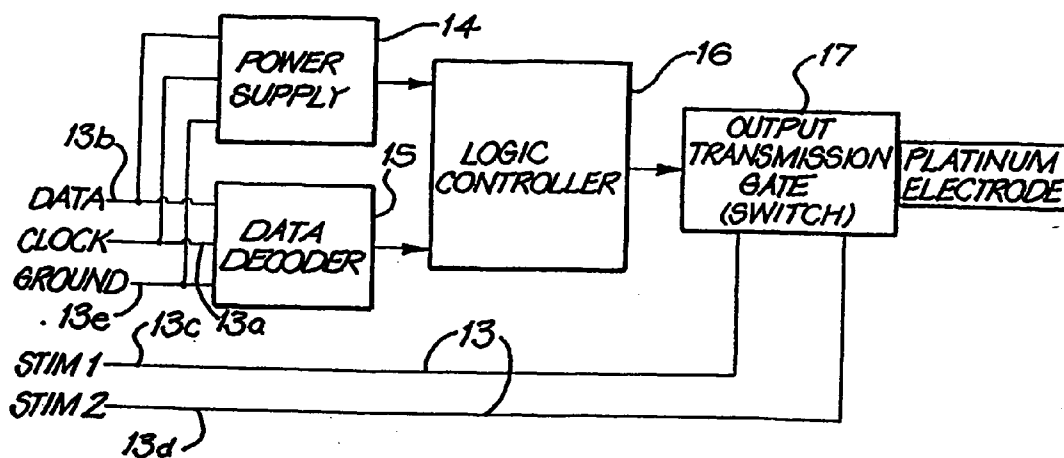


FIG. 1

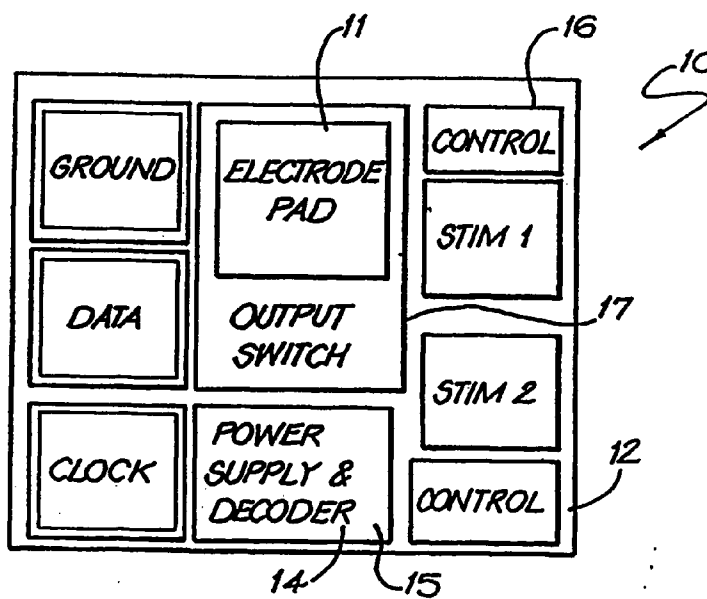


FIG. 2

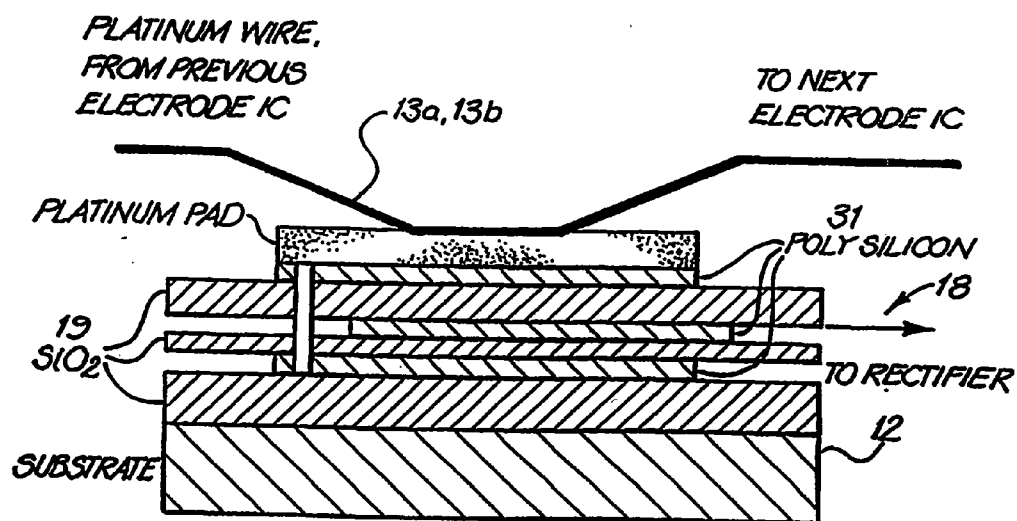


FIG. 3

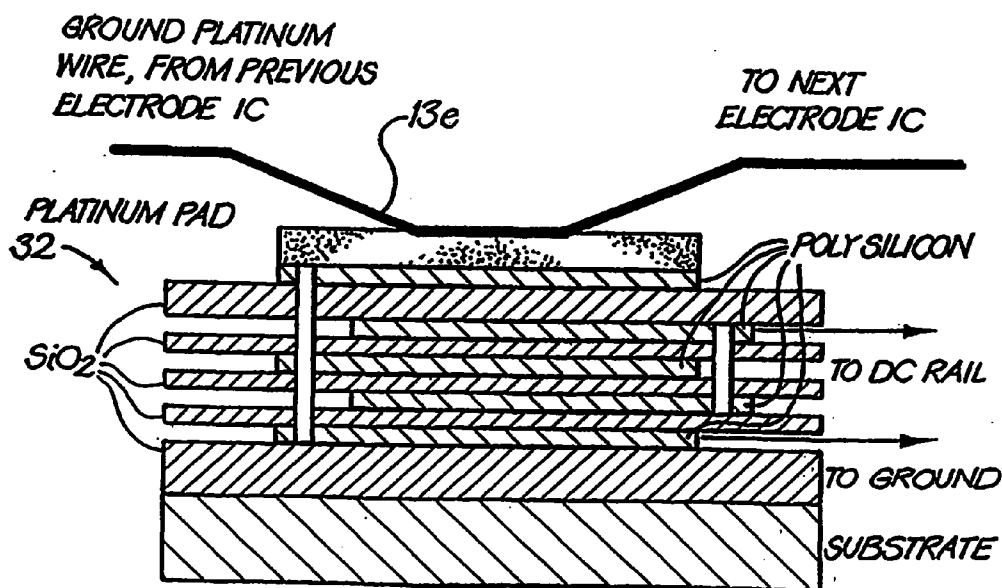


FIG. 4

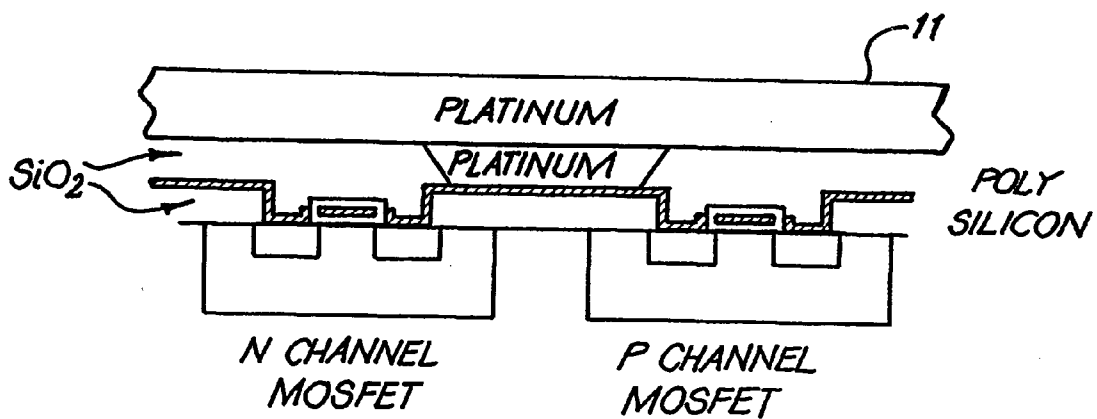


FIG. 5

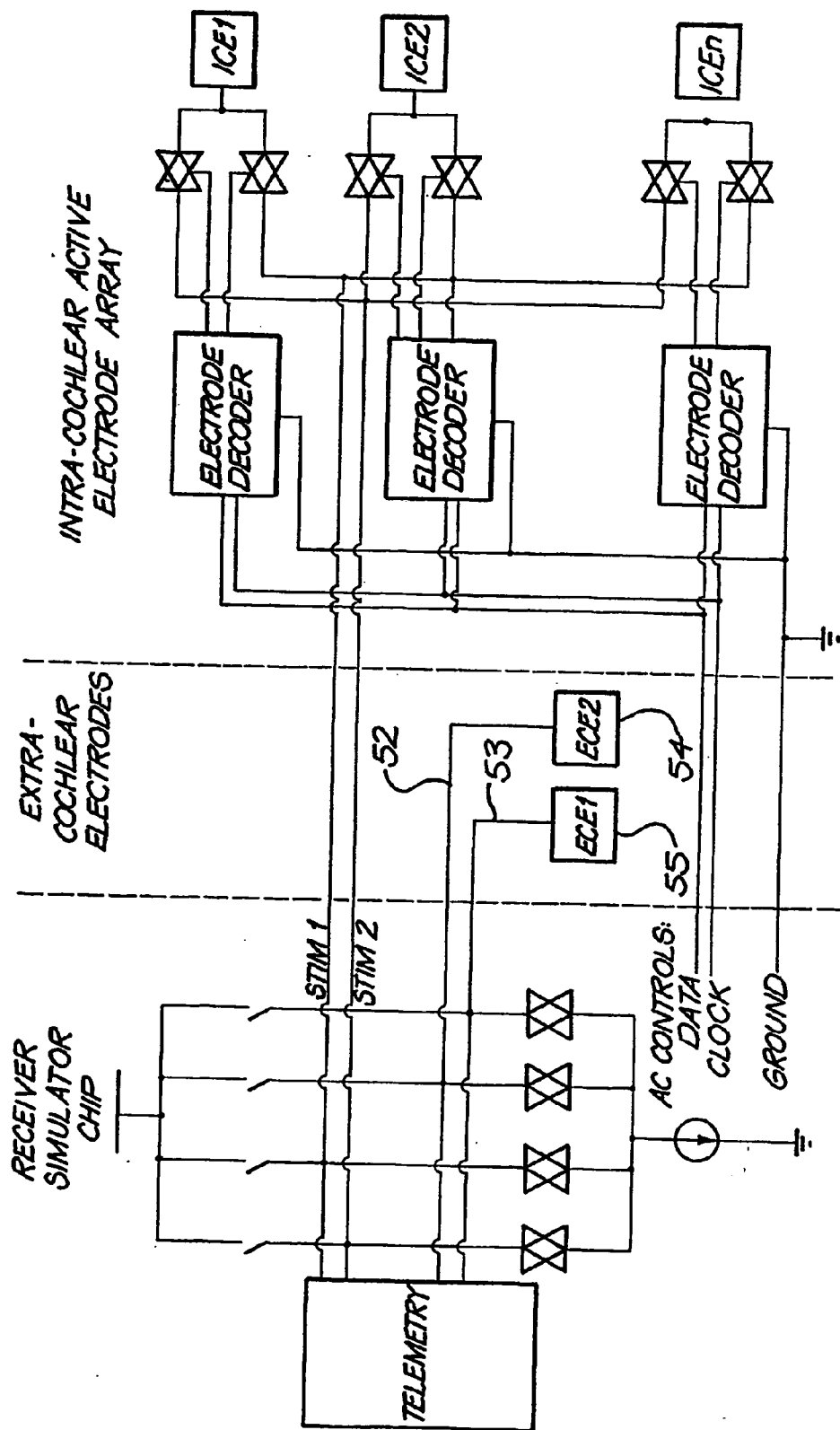


FIG. 6

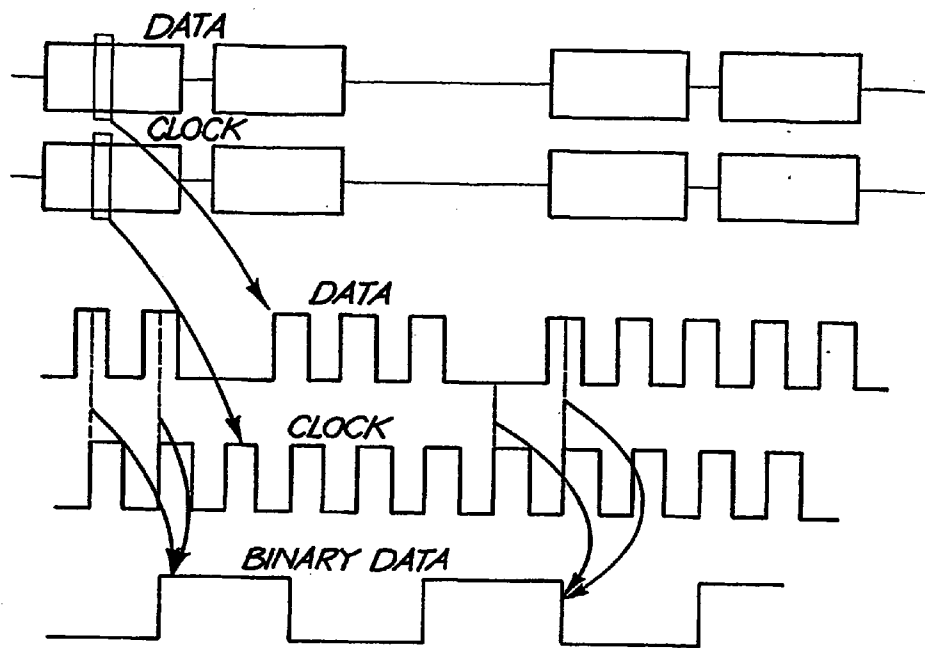


FIG. 7

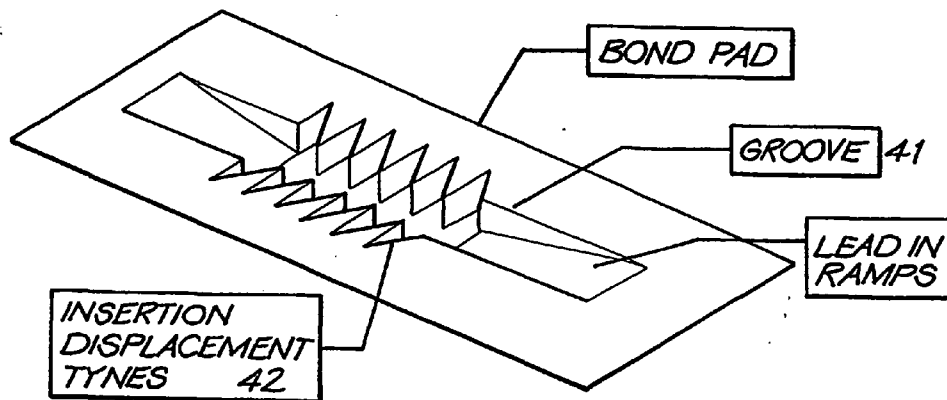


FIG. 8

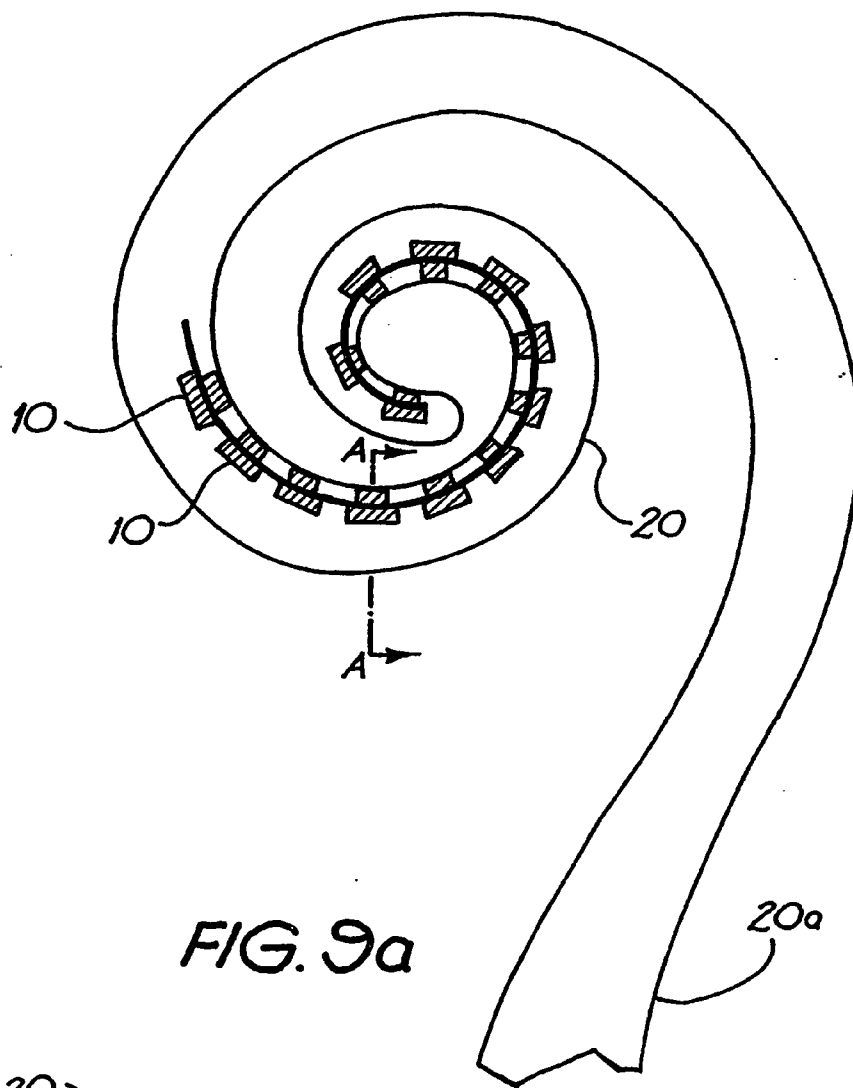


FIG. 9a

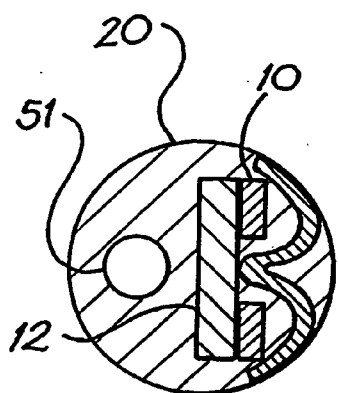


FIG. 9b

SECTION A-A

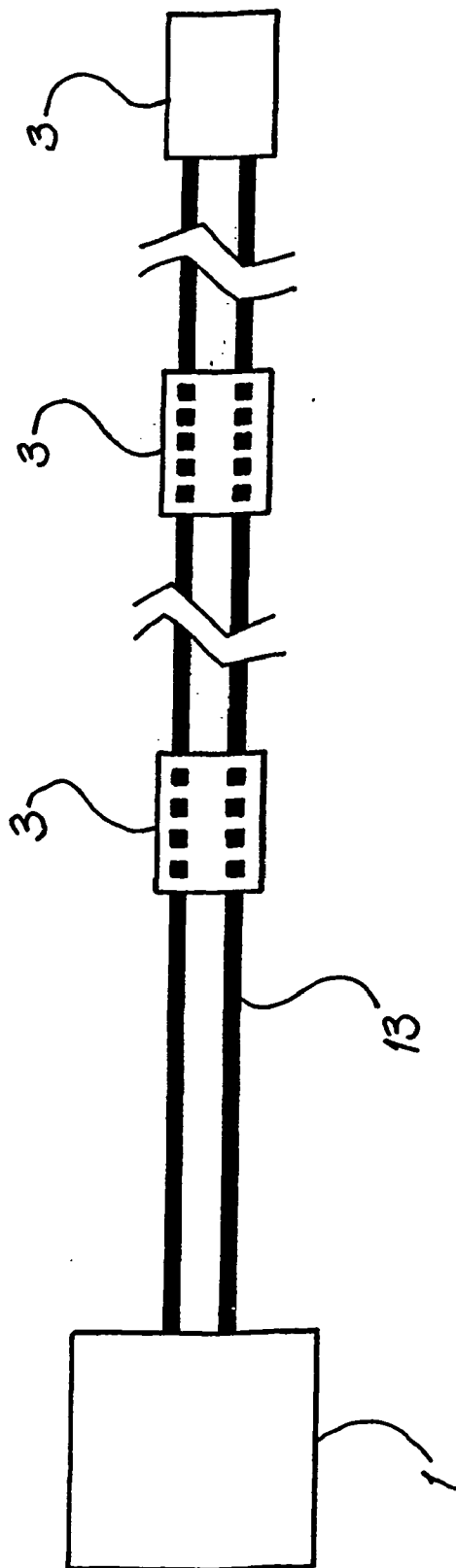


FIG. 10



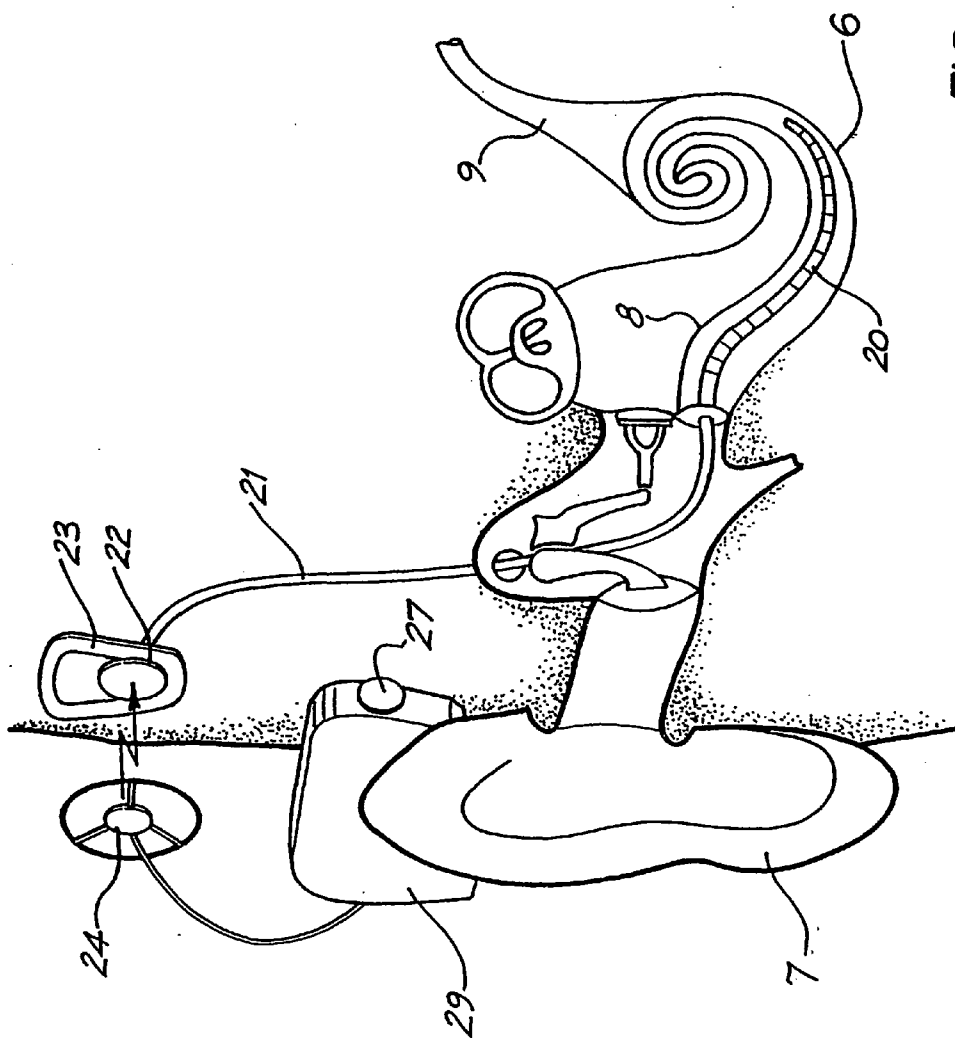


FIG. 11

**MULTI-ELECTRODE COCHLEAR IMPLANT SYSTEM WITH DISTRIBUTED ELECTRONICS**

**FIELD OF THE INVENTION**

[0001] The present invention relates to a tissue-stimulating prosthesis and, in particular, to an implantable tissue-stimulating prosthesis, such as an electrode array for a cochlear implant-type auditory prosthesis.

**BACKGROUND OF THE INVENTION**

[0002] Cochlear implants have been developed to assist people who are profoundly deaf or severely hearing impaired, by enabling them to experience hearing sensation representative of the natural hearing sensation. In most of these cases, the individuals have an absence of or destruction of the hair cells in the cochlea which naturally transduce acoustic signals into nerve impulses which are interpreted by the brain as sound. The cochlear implant therefore bypasses the hair cells to directly deliver electrical stimulation to the auditory nerves with this electrical stimulation being representative of the sound.

[0003] Cochlear implants have traditionally consisted of two parts, an external speech processor unit and an implanted receiver/stimulator unit. The external speech processor unit has normally been worn or carried on the body of the user and its main purpose has been to detect sound with a microphone and convert the detected sound into a coded signal through an appropriate speech processing strategy.

[0004] This coded signal is then sent to the receiver/stimulator unit which is normally implanted in the mastoid bone of the user, via a transcutaneous radio frequency (RF) link. The receiver/stimulator unit includes a circuit that processes this coded signal and outputs a series of stimulation sequences. These sequences are transmitted to appropriate electrodes of an electrode array by respective electrically conducting wires. The array is positioned proximal to the modiolus of the cochlea such that an electrical stimulus output by the electrodes is then applied to the auditory nerve.

[0005] As the electrode array is typically surgically implanted within the scala tympani of the cochlea of the recipient, the dimensions of the array and the manner of its insertion must be such so as to avoid damage to the sensitive structures of the cochlea. The dimensions and spiral shape of the cochlea also limit the maximum dimensions, particularly the diameter, and the stiffness of any array used as part of a cochlear implant.

[0006] In existing designs, this has limited the number of electrically conducting electrodes that can be incorporated into the array, due in the main to limitations imposed on the number of wires that can extend through the array to the electrodes. Traditional electrode array designs have required one or more conductive wires to be connected to each electrode and as such for an array having, for example 22 electrodes, the minimum number of wires required would be 22. With an increased understanding of the tonotopic nature and behaviour of the cochlea, the benefits of providing an increased number of stimulating electrodes within the cochlea to stimulate more discrete sites within the cochlea are now being realised. However, it has been demonstrated that increasing the number of wires in conjunction with an

increased number of electrodes unacceptably increases the dimensions and stiffness of the array. Merely reducing the diameter of the wires, in order to keep the overall dimensions unchanged, leads to an unacceptable increase in lead resistance. As a result, this limitation on the number of leads, and hence electrodes, limits the scale and type of electrical stimulations that can be applied to the auditory nerve by the electrode array.

[0007] The present invention provides a solution to this problem by allowing an increase in the number of individual electrodes of an electrode array of a cochlear implant in comparison to known arrays while still allowing the array to be readily inserted within a implantee's cochlea.

[0008] Further to this, the present invention in combination with new methods of manufacturing electrode arrays as described in the Applicant's co-pending International Patent Application PCT/AU02/00575, provides for significant improvements in the size and design of intra-cochlear electrode arrays than has previously been the case.

[0009] Any discussion of documents, acts, materials, devices, articles or the like which has been included in the present specification is solely for the purpose of providing a context for the present invention. It is not to be taken as an admission that any or all of these matters form part of the prior art base or were common general knowledge in the field relevant to the present invention as it existed before the priority date of each claim of this application.

**SUMMARY OF THE INVENTION**

[0010] Throughout this specification the word "comprise", or variations such as "comprises" or "comprising", will be understood to imply the inclusion of a stated element, integer or step, or group of elements, integers or steps, but not the exclusion of any other element, integer or step, or group of elements, integers or steps.

[0011] According to a first aspect, the present invention is an implantable tissue-stimulating device comprising a carrier member having a plurality of electrode elements mounted thereon, and at least one signal transmitting means extending through at least a portion of the carrier member and adapted to transmit signals through the carrier member to and/or from said plurality of electrode elements, wherein the number of transmitting means within the carrier member is less than the number of electrode elements mounted thereon.

[0012] According to a second aspect, the present invention is an implantable tissue-stimulating device comprising a carrier member having a plurality of electrode elements mounted thereon, at least one of the electrode elements having associated signal processing circuitry embedded within the carrier member proximate thereto.

[0013] In a preferred embodiment, the tissue-stimulating device of both aspects can comprise an implantable component of a cochlear implant device. While having broader application, the present invention will be defined for the purposes of the present application with reference to a cochlear implant. For the purposes of the present specification, the cochlear implant is defined as including a receiver/stimulator circuit which is implanted in the mastoid bone of the implantee. The receiver/stimulator unit includes a circuit that processes a coded signal transmitted transcutaneously

from an external component and outputs a series of signals through the carrier member to the electrodes and/or the embedded circuitry of the carrier member. While a typical cochlear implant will include an external component including a microphone and speech processor, it will be appreciated that the cochlear implant could be fully implantable within the implantee.

[0014] In a preferred embodiment, the plurality of electrode elements define a longitudinal array of elements. In a further embodiment, the electrode elements each have a respective contact face exposed along a first, preferably longitudinal, side of the carrier member. In one embodiment, the contact faces can be equally spaced along the carrier member. In another embodiment, the spacing between respective pairs of contact faces can vary. In another embodiment, respective pairs of electrodes can be adapted to provide bipolar stimulation. In another embodiment, the electrode or electrodes can provide monopolar stimulation or common ground stimulation to the auditory nerve in the cochlea.

[0015] The electrode elements can be formed of a biocompatible material, such as platinum.

[0016] In a further embodiment of the first aspect, the signal transmitting means can comprise an electrically conducting wire or wires. In one embodiment, the wire or wires can also be formed of a biocompatible electrically conducting material, such as platinum. In one embodiment, the device includes at least five signal transmitting means for all of the electrodes in the carrier member. This is in contrast to present known designs which normally have at least one wire for each of the electrodes of the array, eg. at least 32 wires for 32 electrodes.

[0017] The five signal transmitting means can include a clock line, a data line, a first stimulation line, a second stimulation line, and a common ground line.

[0018] In a further embodiment of the first aspect and in the second aspect, each electrode supported by the carrier member has associated electronic circuitry positioned proximate thereto within the carrier member. The circuitry can be associated with one or more electrodes. This circuitry can be positioned immediately adjacent the electrode. In another embodiment, the electrode and its associated circuitry are integrated on a common substrate to form an integrated circuit. The circuitry and substrate are each preferably constructed to be biocompatible, with preferably no metal interlayers being utilised. Instead, polysilicon is preferably used to provide low impedance pathways within the circuitry.

[0019] The electronic circuitry can include a power rectifier, a data decoder, a control circuit, and/or an output switch.

[0020] DC power for its associated electrode is preferably produced by the power rectifier by rectifying an AC power source provided to the power rectifier. The AC power is preferably provided on two signal transmitting means extending through the carrier member from the implanted receiver/stimulator circuit. The two signal transmitting means can comprise the data line and the clock line as defined above.

[0021] The data and clock lines are preferably capacitively coupled to the associated electronic circuitry of each of the electrodes in the carrier member using respective input pads.

[0022] The data and clock lines are also preferably coupled to the electrode via small coupling capacitors formed under, and including, the data and clock bond pads.

[0023] The circuitry preferably includes a ground pad. The ground pad is preferably bonded to a platinum wire that connects to the ground of the receiver/stimulator circuit, ie. the common ground line. It is also preferably connected to the common ground of the electronic circuit of the electrode.

[0024] The stimulus pads of the integrated substrate are preferably constructed using standard CMOS bond pad design. These pads preferably do not require protection diodes.

[0025] The data decoder preferably demodulates data and power signals transmitted from the receiver/stimulator circuit, extracts the data and decodes it to obtain the stimulation and telemetry control parameters. Each electrode data decoder preferably determines whether its associated electrode is required to output an electrical stimulation. By devolving this decoding step to circuitry embedded with the respective electrodes, the number of electrical connections between the electrodes and the receiver/stimulator passing through the carrier member can be reduced.

[0026] The control circuit is preferably used to configure the electrode output in accordance with the stimulus and telemetry data decoded by the data decoder.

[0027] The output switch (transmission gate) preferably directs the stimulation current to the selected electrode and/or connects the selected electrode to a telemetry measurement circuit. Each output switch also preferably controls the shorting of the electrodes during an inter-frame period, or to open the electrode outputs during voltage and neural response telemetry. The platinum electrode is preferably directly bonded to the drains of transistors within the output switch.

[0028] In one embodiment, the wires forming the respective signal transmitting means extend from at least the proximal end of the carrier member for a length through the carrier member that includes the electrodes.

[0029] The wires are preferably electrically insulated. A ribbon wire can be used to provide the signal transmitting means. The electrical insulation can comprise parylene. Where necessary, the insulation can be ablated using excimer laser ablation. The insulation is preferably ablated at fixed intervals corresponding to the positions of the input pads within the carrier member of each embedded circuit.

[0030] In one embodiment, the wire can be gap welded to the input pads using an appropriate gap welder.

[0031] In another embodiment, the input pads can be fabricated to form insertion displacement connectors. The connector can be fabricated by micromachining a cavity having a plurality of sharp tines formed in the surface thereof. On pushing the wire into this cavity, the sharp tines can pierce the insulation of the wire and so make electrical connection with the wire.

[0032] The carrier member can be formed by molding a suitable biocompatible polymer around the wires, circuitry and electrodes.

[0033] The carrier member can be formed to have a first configuration selected to allow said member to be inserted

into an implantee's body and at least a second configuration wherein said carrier member is adapted to apply a preselected tissue stimulation with the electrodes.

[0034] A stiffening element having a configuration selected for biasing said carrier member into said first configuration can pass through at least a portion of the carrier member. The stiffening element can be a metallic stylet disposed in a lumen passing through the carrier member.

[0035] In a preferred embodiment, the second configuration of the carrier member is curved. More preferably, the carrier member adopts a spiral configuration when in the second configuration.

[0036] In a preferred embodiment, the first configuration is preferably substantially straight. More preferably, the first configuration is straight.

[0037] In a preferred embodiment, the carrier member is formed from a suitable biocompatible material. In one embodiment, the material can be a silicone, such as Silastic MDX 4-4210. In another embodiment, the carrier member can be formed from a polyurethane.

[0038] In a preferred embodiment, the receiver/stimulator circuit of the cochlear implant is electrically connected to the data and clock lines. It is also preferably electrically connected to and drives four output stimulation lines. Two of these lines are preferably connected to two extra-cochlear electrodes. The other two lines, hereinafter called "stim 1" and "stim 2", extend through the carrier member and are connected to the respective input pads of the embedded circuits.

[0039] Each of the four lines can be connected, under the control of the receiver/stimulator circuit, to either VDD or to an on-chip stimulus current source.

[0040] The stimulation charge, delivered to the cochlea, is preferably balanced by using a two-phase balanced stimulation scheme. During the first phase, the active electrode is connected to the current source while the reference electrode is connected to VDD. This allows the current to flow from the reference electrode, through the cochlea and other tissue, to the active electrode. During the second phase, the electrode connections are reversed allowing equal, but opposite polarity, charge to flow through the cochlea. This preferably results in a balanced (zero average) charge flow through the stimulating electrodes and the human tissue.

[0041] Despite the above, precise charge balance may not be achievable in practice due to small timing errors or variation in electrode properties. To overcome this problem, the output transmission gates (switches) are preferably closed after the second stimulation phase, thereby connecting all intra-cochlea electrodes to stim 1 and stim 2 simultaneously. These electrodes can be connected to VDD via the output switches of the receiver/stimulator circuit. Depending on the desired shorting scheme, the extra-cochlear electrodes may also be shorted to VDD together with the intra-cochlea electrodes in order to simultaneously discharge any residual charge on all electrodes. The insertion of series capacitors with some, or all, of the four output lines of the receiver/stimulator circuit preferably guarantees the longer term charge balance of the system.

[0042] As discussed, the implant is preferably capable of three stimulation modes. Monopolar stimulation is obtained by selecting an extra-cochlear electrode and an intracochlear electrode as the stimulating electrodes. In this mode, the post-stimulating shorting must involve the extra-cochlea electrodes.

[0043] The bipolar stimulation is preferably achieved by selecting two intra-cochlear electrodes as the stimulating electrodes. The post-stimulation shorting, in this case, does not need to involve the extra-cochlear electrodes.

[0044] The Common Ground stimulation is obtained by selecting an intra-cochlea electrode as an active electrode (connected to stim 1), while all other intra-cochlea electrodes are connected in parallel to stim 2 by simultaneously closing their output switches (transmission gates) during the stimulus phases.

[0045] A telemetry circuit can reside in the receiver/stimulator circuit and be connected to the four output lines. This preferably enables the telemetry circuit to measure the voltage of any of the four lines with respect to an internal reference, or differentially between any two of the four lines.

[0046] Three telemetry functions are preferably available when using the system, namely Current Source Voltage Compliance Telemetry, Voltage Telemetry, and Neural Response Telemetry.

[0047] Current Source Voltage Compliance Telemetry is preferably used to measure the voltage across the stimulation current source of the receiver/stimulator circuit. This telemetry function returns one of two states indicating the voltage across the current source during stimulation. If the measured voltage falls below a design threshold, it may not then be sufficient to maintain the correct operation of the current source. This telemetry function is available for both monopolar and bipolar stimulation modes.

[0048] Electrode Voltage Telemetry is preferably used to measure the voltage of an intra-cochlea electrode during stimulation. When voltage telemetry is used to measure the voltage of the active electrode, it can then be used with either monopolar or bipolar stimulation modes. However, only monopolar stimulation can facilitate using Voltage telemetry to measure the voltage of a non-stimulating intra-cochlea electrode, where one of the two lines, stim 1 and stim 2, is used to carry the monopolar stimulation current while the other is used as a sense line to connect to the electrode to be measured.

[0049] Neural Response Telemetry can preferably be used to measure the evoked potential of the auditory nerve after stimulation. This is achieved in monopolar mode by using either stim 1 or stim 2 as a sense line for the neural response electrode. To reduce the stimulation artefacts, one of the extra-cochlea electrodes can be used as a stimulation reference electrode, while the other can be used as a reference electrode for the neural response measurement.

#### BRIEF DESCRIPTION OF THE DRAWINGS

[0050] By way of example only, a preferred mode of carrying out the invention is described with reference to the accompanying drawings, in which:

[0051] FIG. 1 is a block diagram of one embodiment of the embedded circuitry in a carrier member for an electrode;

[0052] FIG. 2 is a plan view of the embedded circuitry;

[0053] FIG. 3 is a cross-sectional view of the data and clock input pads of the is circuitry of FIG. 2;

[0054] FIG. 4 is a cross-sectional view of the ground pad and power supply bypass capacitor of the circuitry of FIG. 2;

[0055] FIG. 5 is a cross-sectional view of the output switch and platinum electrode of the circuitry of FIG. 2;

[0056] FIG. 6 is a schematic diagram of the stimulation/telemetry system used in the circuitry of the present invention;

[0057] FIG. 7 is one example of a possible data protocol for use in the present invention;

[0058] FIG. 8 is a perspective view of one example of a bond pad for use in the present invention;

[0059] FIGS. 9a and 9b are views of one embodiment of a carrier member having an array of electrodes and associated embedded circuitry positioned therealong;

[0060] FIG. 10 is a schematic overview of the present invention; and

[0061] FIG. 11 is a simplified pictorial representation of a prior art cochlear implant system.

#### PREFERRED MODE OF CARRYING OUT THE INVENTION

[0062] While it is to be understood that the present invention has wider application, the invention will be hereinafter described with reference to its application in a cochlear implant.

[0063] Before describing the features of the present invention, it is appropriate to briefly describe the construction of one type of known cochlear implant system with reference to FIG. 11.

[0064] Known cochlear implants typically consist of two main components, an external component including a speech processor 29, and an internal component including an implanted receiver and stimulator unit 22. The external component includes a microphone 27. The speech processor 29 is, in this illustration, constructed and arranged so that it can fit behind the outer ear 7. Alternative versions may be worn on the body or be totally implantable. In the depicted arrangement, a transmitter coil 24 receives signals from the speech processor 29 which in turn transmits electrical signals to the implanted unit 22 via a radio frequency (RF) link.

[0065] The implanted component includes a receiver coil 23 for receiving power and data from the transmitter coil 24. A cable 21 extends from the implanted receiver and stimulator unit 22 to the cochlea 6 and terminates in an electrode carrier 20. The signals thus received are applied by the electrodes of the carrier 20 to the basilar membrane 8 thereby stimulating the auditory nerve 9. The operation of such a device is described, for example, in U.S. Pat. No. 4,532,930.

[0066] A schematic overview of the present invention is shown in FIG. 10. In this overview, a centralised electronics package 1 is provided and can be considered to be the receiver and stimulator unit as described above. A number of

stimulating sites 3 are shown which consist of a plurality of contact surfaces arranged so as to deliver stimulation to the desired tissue. In the present invention, each stimulation site will include embedded electronic circuitry as will be discussed in more detail below. Connecting each stimulation site 3 and the centralised electronics 1 are connecting wires or cables 13. The function of the connecting wires or cables 13 is to supply the power, stimulation site address and stimulation data etc issued from the centralised electronics 1, to be processed and delivered by the stimulation sites 3.

[0067] As can be appreciated by this simplified overview, with such an arrangement not only will the array containing the stimulation sites be able to include more stimulation sites, but due to the lack of wires required to connect to each stimulation site separately; the array will be more flexible and easily manoeuvrable. Further to this benefit, as the stimulation sites will contain electronics, the need to house all the electronics in the centralised electronics package 1 will be reduced, resulting in the size of the centralised electronics package 1 becoming smaller.

[0068] One possible layout of the embedded circuitry 10 associated with an electrode 11 of a stimulation site 3 is depicted in FIG. 2. In the depicted embodiment, the circuitry is provided on a substrate 12 that is square in shape. In the depicted embodiment, the sides of the substrate 12 are 500 microns in length; with the bond pads for the circuits each being squares having side lengths of about 100 microns.

[0069] The depicted circuitry 10 is adapted to control the stimulation output by an associated platinum electrode 11 that is integrated on the substrate 12 supporting the remainder of the circuitry 10. A plurality of such embedded circuits with associated electrodes 11 are disposed along at least a portion of the length of the carrier 20 (see FIGS. 9a and 9b).

[0070] Extending through the carrier 20 from the receiver/stimulator 22 are at least five electrically conducting wires or cables 13. The wires 13 are formed from a biocompatible material, such as platinum.

[0071] The five wires include a clock line 13a, a data line 13b, a first stimulation line 13c, a second stimulation line 13d, and a common ground line 13e.

[0072] The electronic circuitry 10 for each electrode 11 includes a power rectifier 14, a data decoder 15, a control circuit 16, and an output switch 17.

[0073] DC power for its associated electrode 11 is produced by the power rectifier 14 which rectifies AC power provided to the rectifier 14 on the data line 13b and clock line 13a.

[0074] The data line 13b and clock line 13a are capacitively coupled to the electronic circuitry 10 of each of the electrodes 11 in the carrier 20 using respective input pads 18, such as is depicted in FIG. 3. The data line 13b and clock line 13a are coupled to the circuitry 10 via small coupling capacitors formed under, and including, the data and clock bond pads. The pad structure 18 depicted in FIG. 2 is designed to allow the application of large AC voltages to the pad 18, up to the breakdown voltage of the silicon oxide layers 19 in the pad. The structure also maximises the coupling capacitance to the rest of the circuitry 10. The pad 18 is comprised of multi-layer, inter-digitised, parallel con-

nected polysilicon plates **31** to form a large coupling capacitance while keeping the surface area, and hence the capacitance to substrate, small. The capacitance to substrate forms a loss path in the pad **18**, where voltage and current losses are incurred, and should be kept to a minimum value.

[0075] The depicted circuitry **10** also includes a ground pad **32**, as depicted in FIG. 4. The ground pad **32** is bonded to the platinum wire **13e** that connects to the ground of the receiver/stimulator circuit, ie. the common ground line. It is also connected to the common ground of the electronic circuit of the electrode. The capacitor formed beneath the ground pad **32** is used as a power supply bypass capacitor.

[0076] The stimulus pads of the integrated substrate **12** are constructed using standard CMOS bond pad design. These pads do not require protection diodes as the output switches **17** are relatively large and have large parasitic diodes to the substrate **12**. The capacitance from each stimulus pad to the substrate **12** is made relatively small by using a relatively thick underlying oxide layer. The stimulus current, connected to this pad is generated by the receiver/stimulator **22**. The current waveform is made of two phases. Each phase carries equal, but opposite polarity, charges such that the average charge per stimulus frame is zero.

[0077] The platinum output electrode **11** is directly bonded to the drain diffusions of the output transistors. The field oxide under the electrode area is made thick enough to reduce the field threshold modulation caused by the change in the electrode voltage during stimulation, as is depicted in FIG. 5.

[0078] The data decoder **15** demodulates data and power signals transmitted from the receiver/stimulator circuit **22**, extracts the data and decodes it to obtain the stimulation and telemetry control parameters. Each electrode data decoder **15** determines whether its associated electrode **11** is required to output an electrical stimulation. By devolving this decoding step to embedded circuitry **10** with the respective electrodes **11**, the number of electrical wires **13** between the electrodes **11** and the receiver/stimulator **22** passing through the carrier **20** are substantially reduced.

[0079] The control circuit **16** is used to configure the electrode output in accordance with the stimulus and telemetry data decoded by the data decoder **15**.

[0080] The output switch (transmission gate) **17** directs the stimulation current to the selected electrode **11** and/or connects the selected electrode **11** to a telemetry measurement circuit. Each output switch **17** also controls the shorting of the electrodes **11** during an inter-frame period, or to open the electrode outputs during voltage and neural response telemetry. The platinum electrode **11** is directly bonded to the drains of the transistors of the output switch **17**.

[0081] In the depicted embodiment, the wires **13** extend from receiver stimulator **22** and through the proximal end **20a** of the carrier **20** to the respective circuits **10**.

[0082] The depicted wires **13** are electrically insulated with parylene. During manufacture, this insulation can be ablated using excimer laser ablation. The insulation is preferably ablated at fixed intervals corresponding to the positions of the input pads **18** within the carrier **20** of each embedded circuit **10**.

[0083] In another arrangement, the wires can be gap welded to the input pads **18** using an appropriate gap welder.

[0084] In yet another embodiment, the wires and the input pads can be made integrally using the method as described in PCT Patent Application No. PCT/AU02/00575, the contents of which is incorporated herein by reference.

[0085] In still another arrangement and as depicted in FIG. 8, the input pads **18** can be fabricated to form insertion displacement connectors. The connector can be fabricated by micromachining a cavity **41** having a plurality of sharp tines **42** formed in the surface thereof (see FIG. 8). On pushing the wire **13** into this cavity **41**, the sharp tines **42** pierce the insulation of the wire **13** and so make electrical connection with the wire **13**.

[0086] The carrier **20** is formed by molding a suitable biocompatible polymer around the wires **13**, circuitry **10** and electrodes **11**.

[0087] The carrier **20** has a first substantially straight configuration selected to allow it to be inserted into an implantee's body and at least a second spirally curved configuration wherein the carrier is adapted to apply a preselected tissue stimulation with the electrodes **11**.

[0088] A stiffening element having a configuration selected for biasing the carrier member into the first configuration can pass through at least a portion of the carrier member. The stiffening element can be a metallic stylet disposed in a lumen **51** passing through the carrier **20**.

[0089] In the depicted embodiment, the carrier **20** is formed from a suitable biocompatible silicone, such as Silastic MDX 4-4210. In another embodiment, the carrier **20** can be formed from a polyurethane.

[0090] In the depicted embodiment, the receiver/stimulator **22** of the cochlear implant is electrically connected to the data line **13b** and the clock line **13a**. It is also electrically connected and drives four output stimulation lines. As depicted in FIG. 6, two of these lines **52,53** are connected to two extra-cochlear electrodes **54,55**. The other two lines, hereinafter called "stim 1" and "stim 2", extend through the carrier member and are connected to the respective input pads of the embedded circuits.

[0091] Each of the four lines can be connected, under the control of the receiver/stimulator circuit, to either VDD or to an on-chip stimulus current source.

[0092] The stimulation charge, delivered to the cochlea, is, in the depicted embodiment, balanced by using a two-phase balanced stimulation scheme. During the first phase, the active electrode **11** is connected to the current source while the reference electrode is connected to VDD. This allows the current to flow from the reference electrode, through the cochlea and other tissue, to the active electrode **11**. During the second phase, the electrode connections are reversed allowing equal, but opposite polarity, charge to flow through the cochlea. This preferably results in a balanced (zero average) charge flow through the stimulating electrodes and the human tissue.

[0093] Despite the above, precise charge balance may not be achievable in practice due to small timing errors or variation in electrode properties. To overcome this problem, the output transmission gates (switches) **17** can be closed

after the second stimulation phase, thereby connecting all intra-cochlea electrodes **11** to stim **1** and stim **2** simultaneously. These electrodes **11** can be connected to VDD via the output switches of the receiver/stimulator circuit **22**. Depending on the desired shorting scheme, the extra-cochlear electrodes **54,55** may also be shorted to VDD together with the intracochlea electrodes **11** in order to simultaneously discharge any residual charge on all electrodes **11**. The insertion of series capacitors with some, or all, of the four output lines of the receiver/stimulator circuit serves to ensure the longer term charge balance of the system.

[0094] As discussed, the implant is preferably capable of three stimulation modes. Monopolar stimulation is obtained by selecting an extra-cochlear electrode, and an intra-cochlear electrode as the stimulating electrodes. In this mode, the post-stimulating shorting must involve the extra-cochlear electrodes.

[0095] The bipolar stimulation is preferably achieved by selecting two intra-cochlear electrodes as the stimulating electrodes. The post-stimulation shorting, in this case, does not need to involve the extra-cochlear electrodes.

[0096] The Common Ground stimulation is obtained by selecting an intra-cochlea electrode as an active electrode (connected to stim **1**), while all other intra-cochlea electrodes are connected in parallel to stim **2** by simultaneously closing their output switches (transmission gates) during the stimulus phases.

[0097] A telemetry circuit can reside in the receiver/stimulator circuit **22** and be connected to the four output lines. This enables the telemetry circuit to measure the voltage of any of the four lines with respect to an internal reference, or differentially between any two of the four lines.

[0098] Three telemetry functions are available when using the system, namely Current Source Voltage Compliance Telemetry, Voltage Telemetry, and Neural Response Telemetry.

[0099] Current Source Voltage Compliance Telemetry is used to measure the voltage across the stimulation current source of the receiver/stimulator circuit. This telemetry function returns one of two states indicating the voltage across the current source during stimulation. If the measured voltage falls below a design threshold, it may not then be sufficient to maintain the correct operation of the current source. This telemetry function is available for both monopolar and bipolar stimulation modes.

[0100] Electrode Voltage Telemetry is used to measure the voltage of an intra-cochlea electrode during stimulation. When voltage telemetry is used to measure the voltage of the active electrode, it can then be used with either monopolar or bipolar stimulation modes. However, only monopolar stimulation can facilitate using Voltage telemetry to measure the voltage of a non-stimulating intra-cochlea electrode, where one of the two lines, stim **1** and stim **2**, is used to carry the monopolar stimulation current while the other is used as a sense line to connect to the electrode to be measured.

[0101] Neural Response Telemetry can be used to measure the evoked potential of the auditory nerve after stimulation. This is achieved in the monopolar mode by using either stim **1** or stim **2** as a sense line for the neural response electrode. To reduce the stimulation artefacts, one of the extra-cochlea

electrodes can be used as a stimulation reference electrode, while the other can be used as a reference electrode for the neural response measurement.

[0102] One possible data protocol for use with the present invention is depicted in FIG. 7. This data protocol is based on modulating the signal on the data line **13b** with the stimulus and telemetry data. Binary data is represented by a sequence of data pulses. A binary data **1** is represented by two successive data pulses. A missing data pulse followed by a data pulse represents a binary zero. The clock signal, however, has all its pulses existing, with the rising edges delayed with respect to the rising edges of the data pulses. The leading edge of the clock pulses are used to latch the data into a shift register. Depending on the stored pattern, the data in the shift register is decoded into binary ones or zeros as depicted in FIG. 7. The binary data is further decoded to extract the stimulation and telemetry functions to be executed on the next stimulation frame.

[0103] In the case where the carrier **20** has 64 electrodes **11**, the binary data is used to select the following:

- [0104] the active electrode (64 choices, ie 6 bits)
- [0105] the reference electrode (64 choices, ie 6 bits)
- [0106] stimulation mode (3 choices, 2 bits)
- [0107] telemetry sense electrode (64 choices, 6 bits)
- [0108] telemetry modes (3 choices, 2 bits)
- [0109] synchronisation sequence (4 bits).

[0110] This adds up to a total of 26 bits of binary data, which will be transmitted over one stimulus frame (2 phases). If a 2 MHz carrier is used, the minimum phase length needs to be 13  $\mu$ s. Assuming that the inter-frame gap and the inter-phase gap are 5  $\mu$ s each, the stimulus frame is 36  $\mu$ s. This is a stimulation frame of 27777 frames per second. Faster stimulation rates can be achieved by either using a higher clock frequency, or by limiting the stimulation and telemetry modes to the most practically used modes.

[0111] The most significant advantage of the present invention is that only a relatively small number of wires **13** need to extend through the carrier **20**. By reducing the number of wires **13**, the cross-sectional area of the carrier **20** is reduced.

[0112] It will be appreciated by persons skilled in the art that numerous variations and/or modifications may be made to the invention as shown in the specific embodiments without departing from the spirit or scope of the invention as broadly described. The present embodiments are, therefore, to be considered in all respects as illustrative and not restrictive.

1. An implantable tissue-stimulating device comprising a carrier member having a plurality of electrode elements mounted thereon, and at least one signal transmitting means extending through at least a portion of the carrier member and adapted to transmit signals through the carrier member to and/or from said plurality of electrode elements, wherein the number of transmitting means within the carrier member is less than the number of electrode elements mounted thereon.

2. An implantable tissue-stimulating device of claim 1 wherein the device is an implantable component of a cochlear implant system.

3. An implantable tissue-stimulating device of claim 1 wherein the plurality of electrode elements define a longitudinal array of electrode elements.

4. An implantable tissue-stimulating device of claim 3 wherein the electrode elements each have a respective contact face exposed along a first side of the carrier member.

5. An implantable tissue-stimulating device of claim 4 wherein the contact faces are equally spaced along the carrier member.

6. An implantable tissue-stimulating device of claim 1 wherein the electrode elements are formed of a biocompatible metal.

7. An implantable tissue-stimulating device of claim 1 wherein the signal transmitting means comprise an electrically conducting wire or wires.

8. An implantable tissue-stimulating device of claim 7 wherein the wire or wires are formed of a biocompatible electrically conducting metal.

9. An implantable tissue-stimulating device of claim 1 wherein the device comprises at least five signal transmitting means.

10. An implantable tissue-stimulating device of claim 9 wherein the five signal transmitting means comprise a clock line, a data line, a first stimulation line, a second stimulation line, and a common ground line.

11. An implantable tissue-stimulating device of claim 10 wherein each electrode supported by the carrier member has associated electronic circuitry positioned proximate thereto within the carrier member.

12. An implantable tissue-stimulating device of claim 11 wherein the circuitry is associated with two or more electrodes.

13. An implantable tissue-stimulating device of claim 11 wherein the circuitry is positioned immediately adjacent the electrode.

14. An implantable tissue-stimulating device of claim 11 wherein an electrode and its associated circuitry are integrated on a common substrate to form an integrated circuit.

15. An implantable tissue-stimulating device of claim 11 wherein the electronic circuitry comprises a power rectifier, a data decoder, a control circuit, and an output switch.

16. An implantable tissue-stimulating device of claim 15 wherein DC power for an associated electrode is produced by the power rectifier by rectifying an AC power source provided to the power rectifier.

17. An implantable tissue-stimulating device of claim 16 wherein the AC power is provided on two signal transmitting means extending through the carrier member from a receiver/stimulator circuit.

18. An implantable tissue-stimulating device of claim 17 wherein the two signal transmitting means comprise the data line and the clock line.

19. An implantable tissue-stimulating device of claim 18 wherein the data and clock lines are capacitively coupled to the associated electronic circuitry of each of the electrodes in the carrier member using respective input pads.

20. An implantable tissue-stimulating device of claim 15 wherein the data decoder demodulates data and power signals transmitted from a receiver/stimulator circuit, extracts the data and decodes it to obtain the stimulation and telemetry control parameters for the associated electrode.

21. An implantable tissue-stimulating device of claim 20 wherein each electrode data decoder determines whether its associated electrode is required to output an electrical stimulation.

22. An implantable tissue-stimulating device of claim 15 wherein the control circuit configures the electrode output in accordance with stimulus and telemetry data decoded by the data decoder.

23. An implantable tissue-stimulating device of claim 15 wherein the output switch directs a stimulation current to the selected electrode and/or connects the selected electrode to a telemetry measurement circuit.

24. An implantable tissue-stimulating device of claim 23 wherein each output switch also controls the shorting of the electrodes during an inter-frame period.

25. An implantable tissue-stimulating device of claim 23 wherein each output switch also opens the electrode outputs during voltage and neural response telemetry.

26. An implantable tissue-stimulating device of claim 11 wherein the respective signal transmitting means are electrically insulated, the electrical insulation being removed at the side of electrical connection to input pads of the associated circuitry.

27. An implantable tissue-stimulating device of claim 26 wherein the signal transmitting means is gap welded to the input pads.

28. An implantable tissue-stimulating device of claim 26 wherein the input pads are insertion displacement connectors.

29. An implantable tissue-stimulating device of claim 28 wherein the connector comprises a cavity having a plurality of sharp tines formed in the surface thereof, the tines being adapted to pierce the insulation of the signal transmitting means positioned therein and so make an electrical connection thereto.

30. An implantable tissue-stimulating device comprising a carrier member having a plurality of electrode elements mounted thereon, at least one of the electrode elements having associated signal processing circuitry embedded within the carrier member proximate thereto.

31. An implantable tissue-stimulating device of claim 30 wherein the number of transmitting means within the carrier member is less than the number of electrode elements mounted thereon.

32. An implantable tissue-stimulating device of claim 30 wherein the circuitry is associated with two or more electrodes.

33. An implantable tissue-stimulating device of claim 30 wherein the circuitry is positioned immediately adjacent the electrode.

34. An implantable tissue-stimulating device of claim 30 wherein an electrode and its associated circuitry are integrated on a common substrate to form an integrated circuit.

35. An implantable tissue-stimulating device of claim 30 wherein the electronic circuitry comprises a power rectifier, a data decoder, a control circuit, and an output switch.

36. An implantable tissue-stimulating device of claim 35 wherein DC power for an associated electrode is produced by the power rectifier by rectifying an AC power source provided to the power rectifier.

37. An implantable tissue-stimulating device of claim 36 wherein the AC power is provided on two signal transmitting means extending through the carrier member from a receiver/stimulator circuit.



**38.** An implantable tissue-stimulating device of claim 38 wherein the two signal transmitting means comprise a data line and a clock line.

**39.** An implantable tissue-stimulating device of claim 38 wherein the data and clock lines are capacitively coupled to the associated electronic circuitry of each of the electrodes in the carrier member using respective input pads.

**40.** An implantable tissue-stimulating device of claim 35 wherein the data decoder demodulates data and power signals transmitted from a receiver/stimulator circuit, extracts the data and decodes it to obtain the stimulation and telemetry control parameters for the associated electrode.

**41.** An implantable tissue-stimulating device of claim 40 wherein each electrode data decoder determines whether its associated electrode is required to output an electrical stimulation.

**42.** An implantable tissue-stimulating device of claim 35 wherein the control circuit configures the electrode output in accordance with the stimulus and telemetry data decoded by the data decoder.

**43.** An implantable tissue-stimulating device of claim 35 wherein the output switch directs a stimulation current to the selected electrode and/or connects the selected electrode to a telemetry measurement circuit.

**44.** An implantable tissue-stimulating device of claim 43 wherein each output switch also controls the shorting of the electrodes during an inter-frame period.

**45.** An implantable tissue-stimulating device of claim 43 wherein each output switch also opens the electrode outputs during voltage and neural response telemetry.

**46.** An implantable tissue-stimulating device of claim 30 wherein the respective signal transmitting means are electrically insulated, the electrical insulation being removed at the side of electrical connection to input pads of the associated circuitry.

**47.** An implantable tissue-stimulating device of claim 46 wherein the signal transmitting means is gap welded to the input pads.

**48.** An implantable tissue-stimulating device of claim 46 wherein the input pads are insertion displacement connectors.

**49.** An implantable tissue-stimulating device of claim 48 wherein the connector comprises a cavity having a plurality of sharp tines formed in the surface thereof, the tines being adapted to pierce the insulation of the signal transmitting means positioned therein and so make an electrical connection thereto.

\* \* \* \* \*